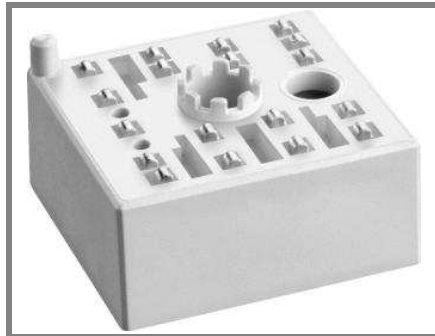


SKiiP 04AC066V1



MiniSKiiP® 0

3-phase bridge inverter

SKiiP 04AC066V1

Features

- Trench IGBT's
- Robust and soft freewheeling diodes in CAL technology
- Highly reliable spring contacts for electrical connections
- UL recognised file no. E63532

Typical Applications*

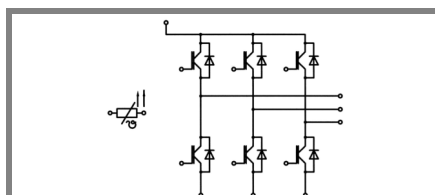
- Inverter up to 6,3 kVA
- Typical motor power 4,0 kW

Remarks

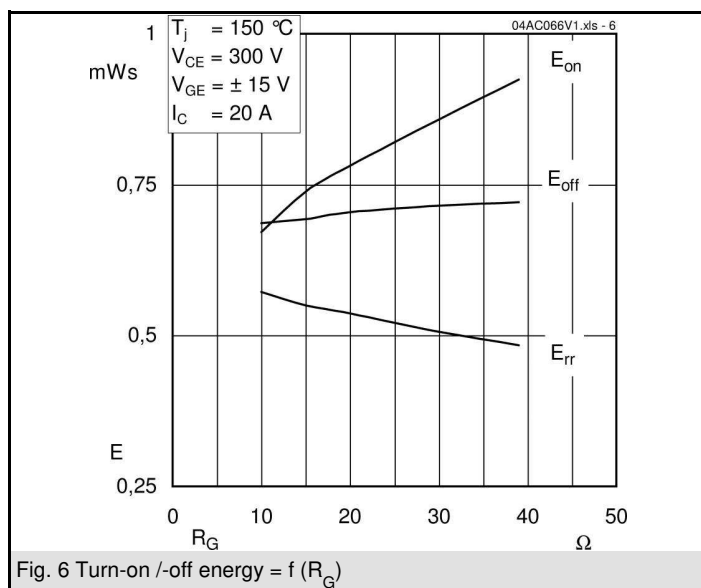
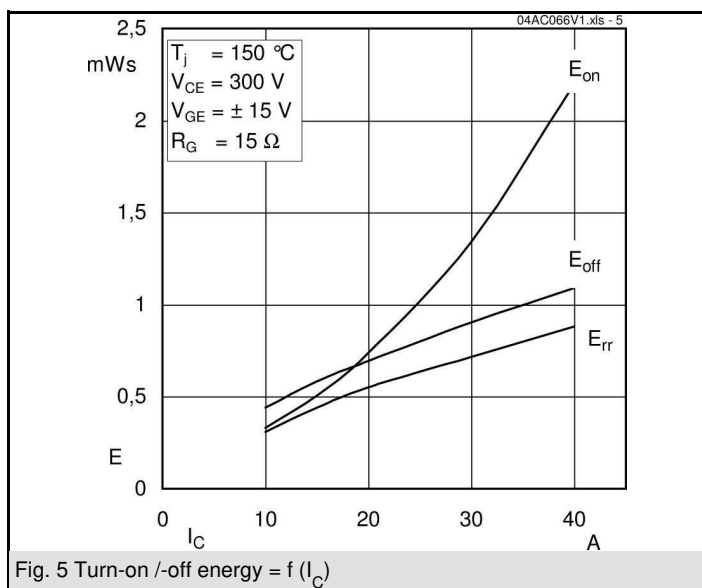
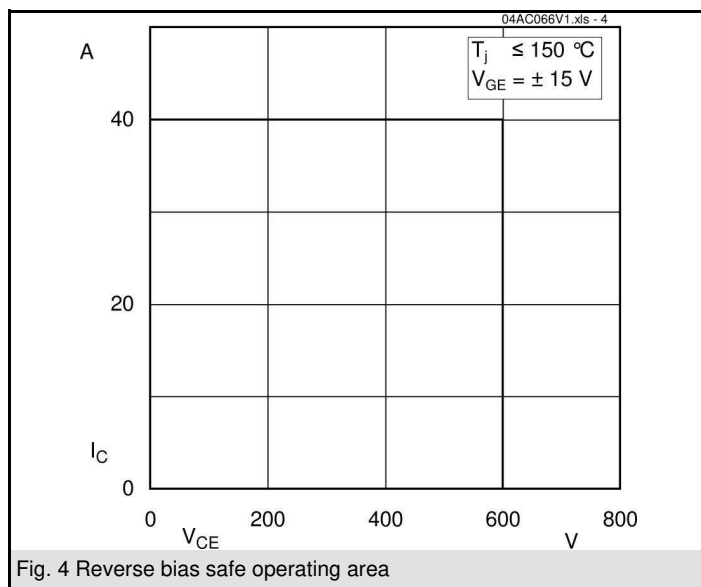
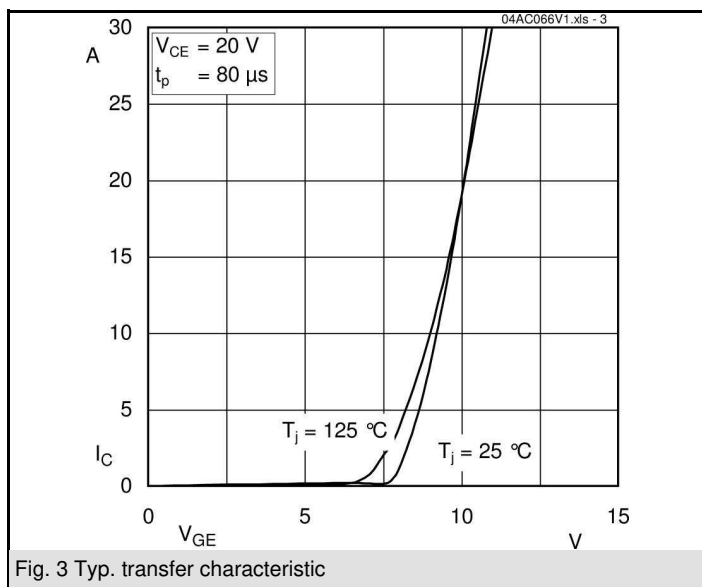
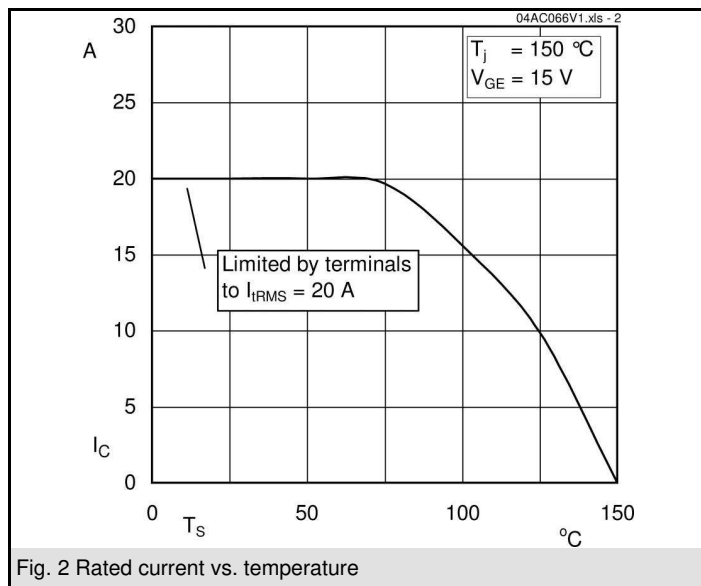
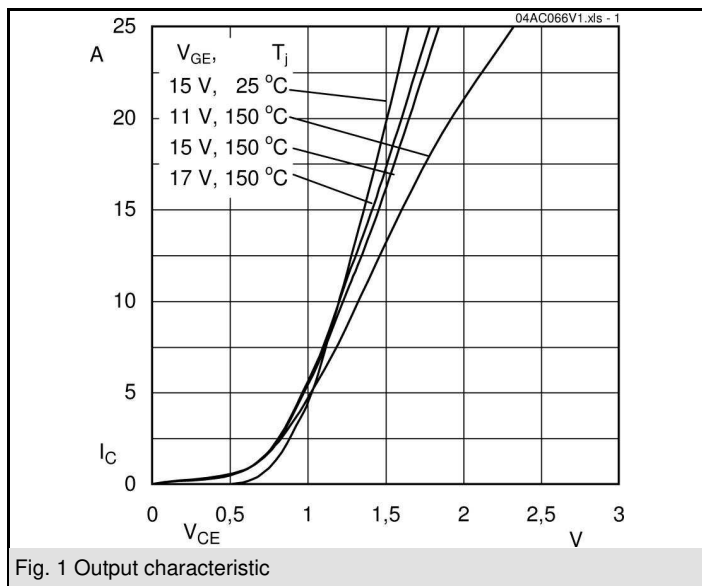
- Case temperature limited to $T_C = 125^\circ\text{C}$ max., product reliability results are valid for $T_j = 150^\circ\text{C}$
- SC data: $t_p \leq 6 \text{ s}$; $V_{GE} \leq 15 \text{ V}$; $T_j = 150^\circ\text{C}$; $V_{CC} = 360 \text{ V}$
- V_{CEsat} , V_F = chip level value
- Temp.Sensor: No basic insulation to main circuit, max. potential difference 850V to -DC

Absolute Maximum Ratings		$T_S = 25^\circ\text{C}$, unless otherwise specified	
Symbol	Conditions	Values	Units
IGBT - Inverter			
V_{CES}		600	V
I_C	$T_S = 25 (70)^\circ\text{C}$, $T_j = 150^\circ\text{C}$	30 (21)	A
I_C	$T_S = 25 (70)^\circ\text{C}$, $T_j = 175^\circ\text{C}$	33 (25)	A
I_{CRM}	$t_p = 1 \text{ ms}$	40	A
V_{GES}		± 20	V
T_j		$-40 \dots +175$	$^\circ\text{C}$
Diode - Inverter			
I_F	$T_S = 25 (70)^\circ\text{C}$, $T_j = 150^\circ\text{C}$	24 (16)	A
I_F	$T_S = 25 (70)^\circ\text{C}$, $T_j = 175^\circ\text{C}$	31 (23)	A
I_{FRM}	$t_p = 1 \text{ ms}$	40	A
T_j		$-40 \dots +175$	$^\circ\text{C}$
I_{RMS}	per power terminal (20 A / spring)	20	A
T_{stg}	$T_{op} \leq T_{stg}$	$-40 \dots +125$	$^\circ\text{C}$
V_{isol}	AC, 1 min.	2500	V

Characteristics		$T_S = 25^\circ\text{C}$, unless otherwise specified			
Symbol	Conditions	min.	typ.	max.	Units
IGBT - Inverter					
V_{CEsat}	$I_{Cnom} = 20 \text{ A}$, $T_j = 25 (150)^\circ\text{C}$	1,1	1,45 (1,65)	1,85 (2,05)	V
$V_{GE(th)}$	$V_{GE} = V_{CE}$, $I_C = 1 \text{ mA}$		5,8		V
$V_{CE(TO)}$	$T_j = 25 (150)^\circ\text{C}$		0,9 (0,85)	1 (0,9)	V
r_T	$T_j = 25 (150)^\circ\text{C}$		30 (42,5)	45 (60)	m Ω
C_{ies}	$V_{CE} = 25 \text{ V}$, $V_{GE} = 0 \text{ V}$, $f = 1 \text{ MHz}$		1,13		nF
C_{oes}	$V_{CE} = 25 \text{ V}$, $V_{GE} = 0 \text{ V}$, $f = 1 \text{ MHz}$		0,25		nF
C_{res}	$V_{CE} = 25 \text{ V}$, $V_{GE} = 0 \text{ V}$, $f = 1 \text{ MHz}$		0,18		nF
$R_{CC'+EE'}$	spring contact-chip $T_S = 25 (150)^\circ\text{C}$				m Ω
$R_{th(j-s)}$	per IGBT		1,6		K/W
$t_{d(on)}$	under following conditions		15		ns
t_r	$V_{CC} = 300 \text{ V}$, $V_{GE} = \pm 15 \text{ V}$		30		ns
$t_{d(off)}$	$I_{Cnom} = 20 \text{ A}$, $T_j = 150^\circ\text{C}$		175		ns
t_f	$R_{Gon} = R_{Goff} = 15 \Omega$		45		ns
$E_{on}(E_{off})$	inductive load		0,8 (0,7)		mJ
Diode - Inverter					
$V_F = V_{EC}$	$I_{Fnom} = 20 \text{ A}$, $T_j = 25 (150)^\circ\text{C}$		1,6 (1,65)	1,9 (1,95)	V
$V_{(TO)}$	$T_j = 25 (150)^\circ\text{C}$		1 (0,9)	1,1 (1)	V
r_T	$T_j = 25 (150)^\circ\text{C}$		30 (37,5)	40 (47,5)	m Ω
$R_{th(j-s)}$	per diode		2,5		K/W
I_{RRM}	under following conditions		27		A
Q_{rr}	$I_{Fnom} = 20 \text{ A}$, $V_R = 300 \text{ V}$		2,25		C
E_{rr}	$V_{GE} = 0 \text{ V}$, $T_j = 150^\circ\text{C}$		0,55		mJ
	$di_F/dt = 1280 \text{ A/s}$				
Temperature Sensor					
R_{ts}	3 %, $T_f = 25 (100)^\circ\text{C}$		1000(1670)		Ω
Mechanical Data					
m			21,5		g
M_s	Mounting torque	2		2,5	Nm



AC



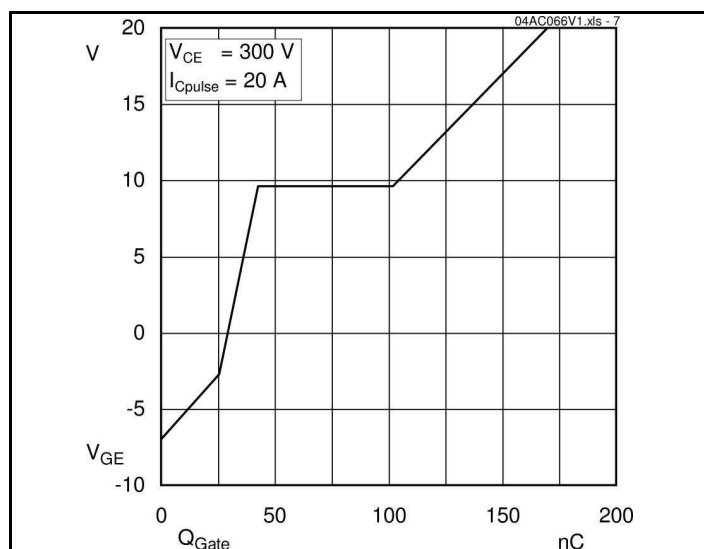


Fig. 7 Typ. Gate charge characteristic

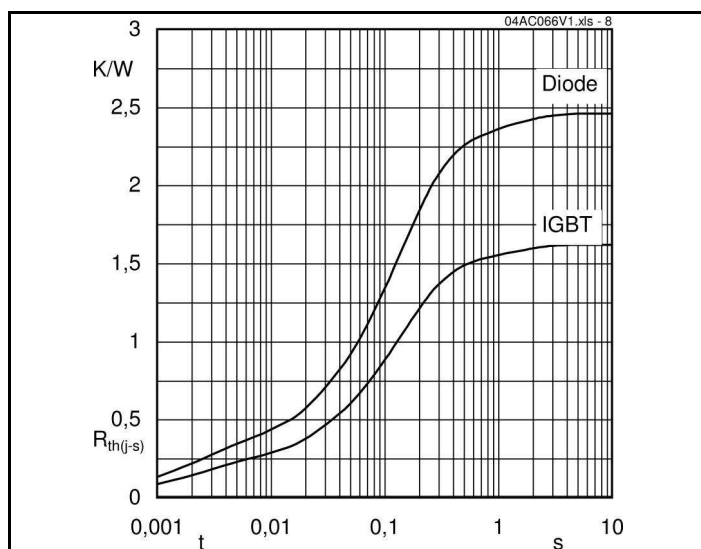


Fig. 8 Thermal impedance

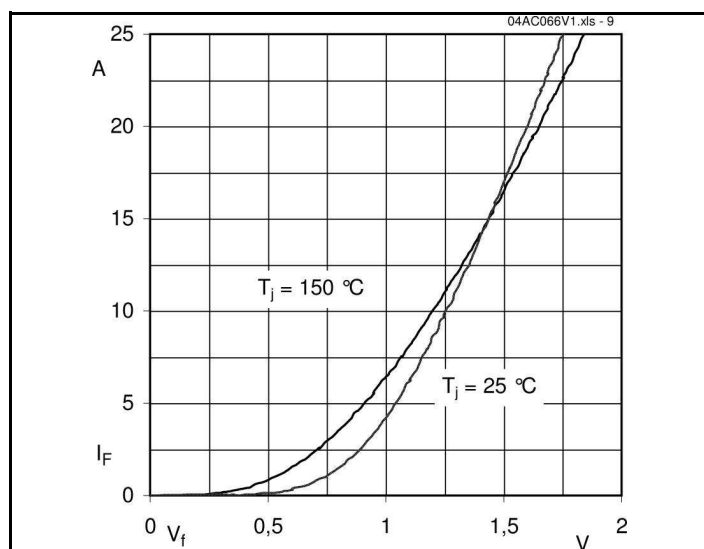
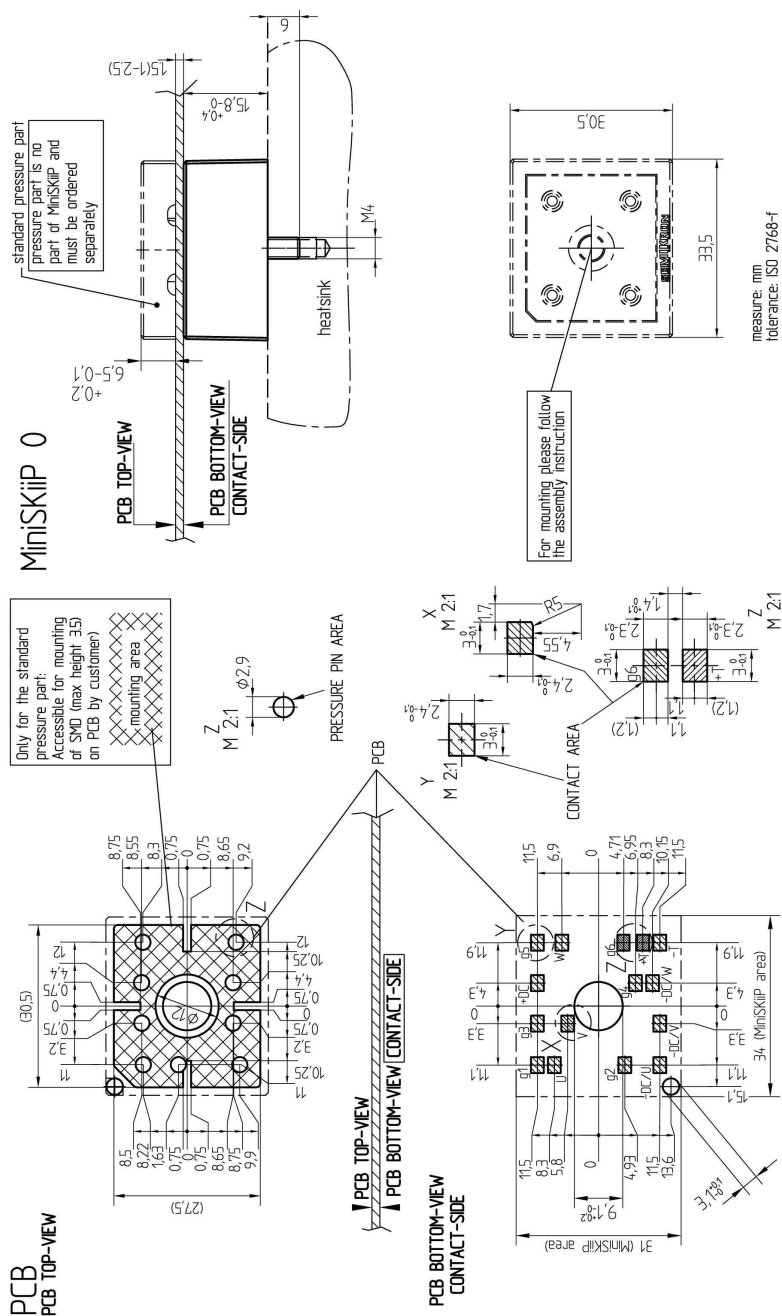
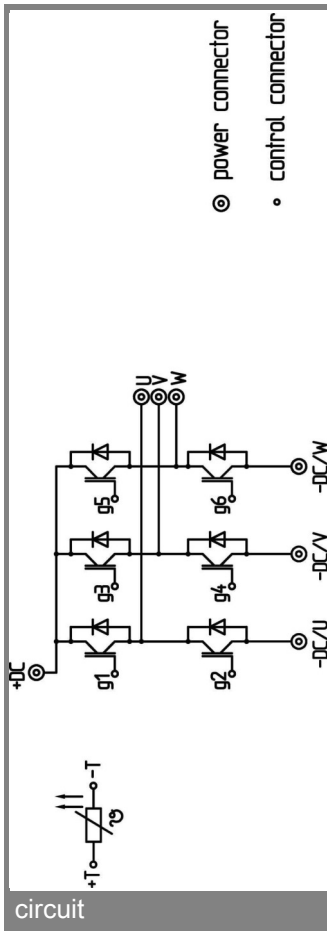


Fig. 9 Freewheeling diode forward characteristic



These documents are Semikron property. Semikron reserves all copyrights. All copying and transmitting of this information requires written permission. For the case of industrial property rights, Semikron reserves all rights.

pinout, dimensions

This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our personal.